

PATENT APPLICATION Attorney Docket No.: 99-230

Date: <u>4/19/00</u>

Assistant Commissioner for Patents Washington, D.C. 20231

ATTN: BOX PATENT APPLICATION

## NEW APPLICATION TRANSMITTAL

Transmitted herewith for filing is the patent application of

Inventor(s): Michael J. Berman

For (title): Determination of Film Thickness During Chemical Mechanical

Polishing

## Enclosed are:

- [x] 4 sheet(s) of drawings. (FORMAL)
- [x] An Assignment of the invention to LSI Logic Corporation
- [X] Declaration enclosed.
- [ ] Material information pursuant to 37 CFR §1.56.
- [ ] It is expressly requested that the U.S. Patent and Trademark Office commence national processing of the above-entitled international application under the provisions of PCT Article 23(2) and 35 USC 371(f).
- [X] Return Postcard

Correspondence Address:

Ralph R. Veseli LSI Logic Corporation M/S D-106 1551 McCarthy Boulevard Milpitas, California 95035 Attorney or Agent of Record

Bruce J. Bowman Req. No. \_\_\_\_35,458

The filing fee has been calculated as shown below:

## CLAIMS AS FILED

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
TOTAL CLAIMS	28 - 20 =	. 8	× \$18	144.00
INDEPENDENT CLAIMS	4 - 3 =	1	x \$78	78.00
			BASIC FEE	\$760.00
			FILING FEE	\$982.00

[X] The Commissioner is hereby authorized to charge any fees under 37 CFR §1.16 and 1.17 which may be required during the pendency of the application to Deposit Account No.13-0014.

"Express mail" mailing label number <u>EL299951282 US</u> Date of Deposit <u>April 19. 2000</u> I hereby certify that this correspondence is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR §1.10 on the date indicated above and is addressed to the Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Bruce J. Bowman

(Name of person mailing application)

(Signature of person mailing application)